146134-5 ACTIVE

AMPMODU | AMPMODU Headers

TE Internal #: 146134-5

AMPMODU Headers, PCB Mount Header, Vertical, Board-to-Board, 12 Position, 2.54mm [.1in] Centerline, Breakaway, Tin-Lead,

Printed Circuit Board

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Connectors > PCB Connectors > Board-to-Board Connectors > Board-to-Board Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 12

Centerline (Pitch): 2.54 mm [.1 in]

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Breakaway
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Number of Rows	2
Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Vertical
Number of Positions	12
Board-to-Board Configuration	Parallel

Electrical Characteristics

Operating Voltage	30 VAC	

Body Features

Connector Profile	Standard	

Contact Features

Mating Square Post Dimension	.64 mm[.025 in]
	100 – 200 μίη



Contact Shape & Form	Square
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Tin-Lead
Contact Mating Area Plating Material Thickness	2.54 – 5.08 μm[100 – 200 μin]
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	2.29 mm
Termination Method to Printed Circuit Board	Surface Mount
Mechanical Attachment	
Mating Alignment	Without
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	2.54 mm[.1 in]
Housing Color	Black
Housing Material	LCP (Liquid Crystal Polymer)
Dimensions	
Dimensions Row-to-Row Spacing	2.54 mm[.1 in]
	2.54 mm[.1 in] 1.57 mm[.062 in]
Row-to-Row Spacing	
Row-to-Row Spacing PCB Thickness (Recommended)	
Row-to-Row Spacing PCB Thickness (Recommended) Usage Conditions	1.57 mm[.062 in]
Row-to-Row Spacing PCB Thickness (Recommended) Usage Conditions Housing Temperature Rating	1.57 mm[.062 in] High
Row-to-Row Spacing PCB Thickness (Recommended) Usage Conditions Housing Temperature Rating Operating Temperature Range	1.57 mm[.062 in] High
Row-to-Row Spacing PCB Thickness (Recommended) Usage Conditions Housing Temperature Rating Operating Temperature Range Operation/Application	1.57 mm[.062 in] High -65 – 125 °C[-85 – 221 °F]
Row-to-Row Spacing PCB Thickness (Recommended) Usage Conditions Housing Temperature Rating Operating Temperature Range Operation/Application Circuit Application	1.57 mm[.062 in] High -65 – 125 °C[-85 – 221 °F]



Packaging Features

Packaging Quantity	35
Packaging Method	Tube

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUN 2020 (209) Candidate List Declared Against: JAN 2020 (205) Does not contain REACH SVHC
Halogen Content	Low Bromine/Chlorine - Br and Cl < 900 ppm per homogenous material. Also BFR /CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series | AMPMODU Headers





Automotive Headers(10)



Board-to-Board Headers & Receptacles(5340)



PCB Connector Mounting(1)



PCB Connector Shrouds(1)



PCB Latches, Locks & Retainers(2)



Wire-to-Board Connector Assemblies & Housings(3)

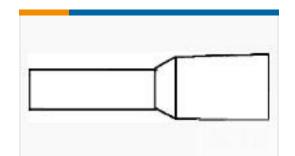


Wire-to-Board Connector Contacts(46)



Wire-to-Board Headers & Receptacles (79)

Customers Also Bought



TE Model / Part #966066-2 ADERENDHUELSE L BL



TE Model / Part #1393481-5 V23529B1225C209=SUB D STIFTLEI



TE Model / Part #8-1624112-9 3650 0603 0.18uH 5% 2K RL



TE Model / Part #5177986-4 0.8FH,P05H.5,100,08/Sn,TR,SC



TE Model / Part #5161390-2 02P.DIP SWITCH ASSY



TE Model / Part #1879026-1 YR1 0.1% 10R2



TE Model / Part #7-1879026-6 YR1 0.1% 41R2



TE Model / Part #216905-1 POSITIVE LOCK POWER RECEPTACLE TPPHBRZ



Documents



Product Drawings

12 MODII HDR DRST SFMNT B/A

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_146134-5_U.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_146134-5_U.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_146134-5_U.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

AMPMODU Interconnetion System

English

AMPMODU Interconnetion System